

Is Now Part of

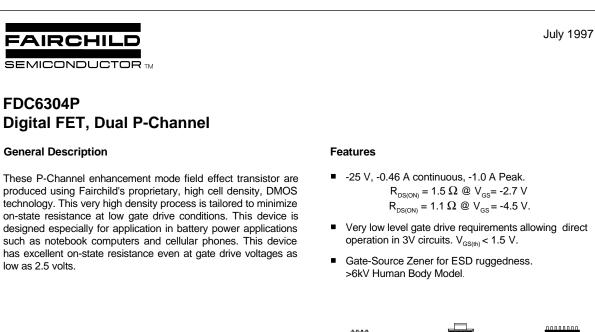


ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or unavteries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out or i, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor and is officers, employees, uniotificated use, even if such claim any manner.



so	OT-23	SuperSOT [™] -6	SuperSOT [™] -6 SuperSOT [™] -8		SOT-223	SOIC-16	
		Mark: .304	G2			- 3	
Absoli Symbol		perSOT™-6 um Ratings _{T_A=2}	S2 G1 25°C unless other wise not		FDC6304P	Units	
V _{DSS}				-25			
/ _{GSS}				-8			
GSS	Drain Current - Continuous			-0.46			
D	- Pulsed			-1			
D	Maximum P	ower Dissipation	(Note 1a)		0.9	W	
U			(Note 1b)		0.7		
Г _Ј ,Т _{STG}	Operating and Storage Temperature Range			-55 to 150			
ESD	Electrostatic Discharge Rating MIL-STD-883D Human Body Model (100pf / 1500 Ohm)			6.0			

(Note 1a)

(Note 1)

1997 Fairchild Semiconductor Corporation

Thermal Resistance, Junction-to-Ambient

Thermal Resistance, Junction-to-Case

THERMAL CHARACTERISTICS

 $\mathsf{R}_{_{\!\!\!\!\!\theta \mathsf{J}\mathsf{A}}}$

 $\mathsf{R}_{\underline{\theta}\mathsf{JC}}$

FDC6304P Rev.D

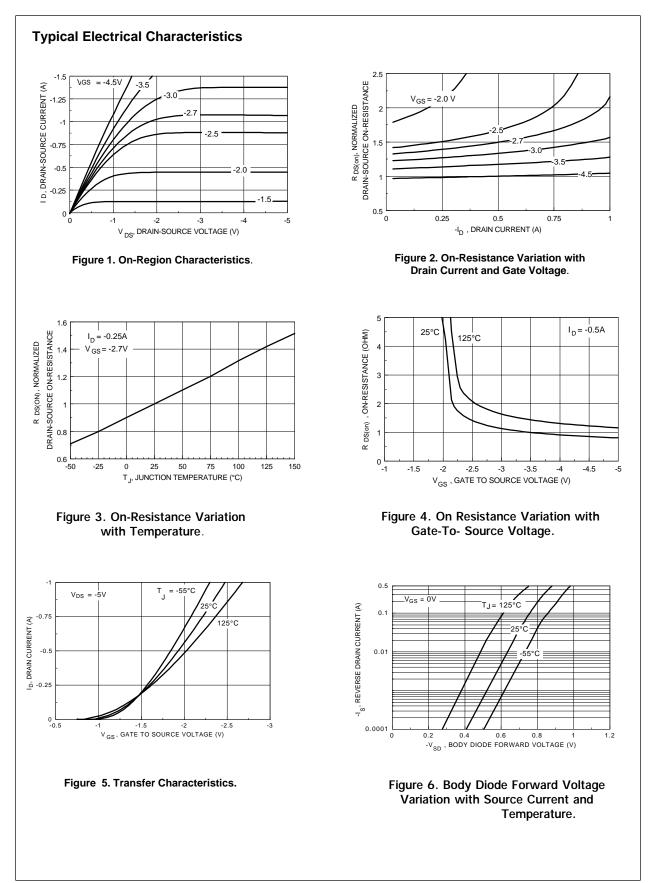
°C/W

°C/W

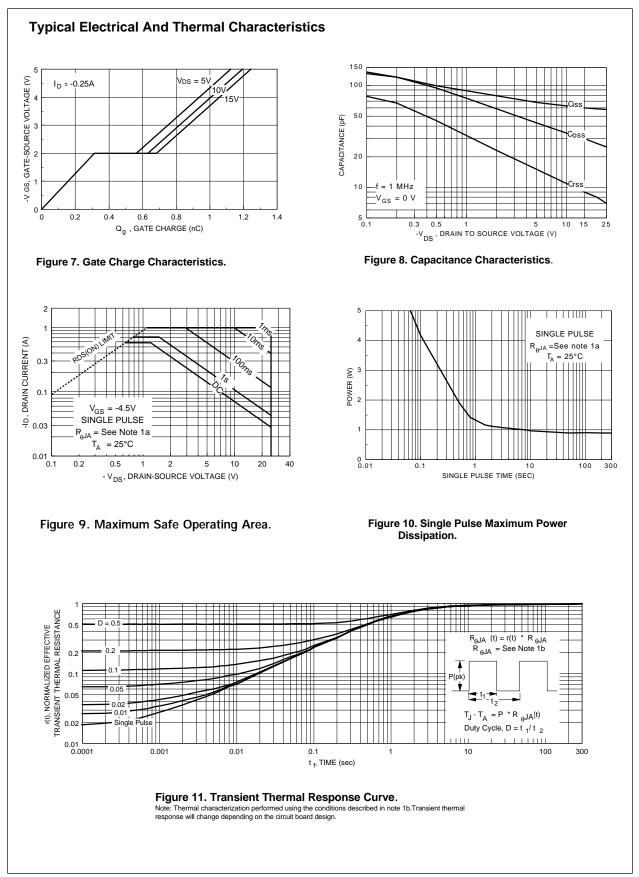
140

60

Symbol	Parameter	Conditions	Min	Тур	Max	Units
OFF CHAR	ACTERISTICS					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = -250 μA	-25			V
$\Delta BV_{DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient	$I_{\rm p}$ = -250 µA, Referenced to 25 °C		-22		mV /°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$			-1	μA
200		$T_{\rm J} = 55^{\circ}{\rm C}$			-10	μA
I _{GSS}	Gate - Body Leakage Current	$V_{GS} = -8 V, V_{DS} = 0 V$			-100	nA
	CTERISTICS (Note 2)					
$\Delta V_{GS(th)} / \Delta T_J$	Gate Threshold Voltage Temp. Coefficient	$I_{\rm D}$ = -250 μ A, Referenced to 25 °C		2.1		mV /°C
V _{GS(th)}	Gate Threshold Voltage	$V_{\rm DS} = V_{\rm GS}, \ I_{\rm D} = -250 \ \mu {\rm A}$	-0.65	-0.86	-1.5	V
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{gs} = -2.7 \text{ V}, \text{ I}_{D} = -0.25 \text{ A}$		1.22	1.5	Ω
. ,		$V_{GS} = -4.5 \text{ V}, I_{D} = -0.5 \text{ A}$		0.87	1.1	1
		T _J =125°C		1.21	2	1
I _{D(ON)}	On-State Drain Current	$V_{GS} = -2.7 \text{ V}, V_{DS} = -5 \text{ V}$	-0.5			A
		$V_{GS} = -4.5 \text{ V}, V_{DS} = -5 \text{ V}$	-1			
9 _{FS}	Forward Transconductance	$V_{\rm DS} = -5 \text{ V}, \ \text{I}_{\rm D} = -0.5 \text{ A}$		0.8		S
DYNAMIC (CHARACTERISTICS		-			
C _{iss}	Input Capacitance	$V_{DS} = -10 V, V_{GS} = 0 V,$ f = 1.0 MHz		62		pF
C _{oss}	Output Capacitance	f = 1.0 MHZ		35		pF
C _{rss}	Reverse Transfer Capacitance			9.5		pF
SWITCHING	G CHARACTERISTICS (Note 2)		-	1	•	
t _{D(on)}	Turn - On Delay Time	$V_{DD} = -6 V, I_D = -0.5 A,$		7	20	ns
t,	Turn - On Rise Time	$V_{\rm GS}$ = -4.5 V, R _{GEN} = 50 Ω		8	20	ns
t _{D(off)}	Turn - Off Delay Time			55	110	ns
t _r	Turn - Off Fall Time			35	70	ns
Q _g	Total Gate Charge	$V_{DS} = -5 V, I_{D} = -0.25 A,$		1.1	1.5	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = -4.5 V$		0.32		nC
Q _{gd}	Gate-Drain Charge			0.28		nC
DRAIN-SOL	JRCE DIODE CHARACTERISTICS AND MAX	IMUM RATINGS		1	T	1
l _s	Maximum Continuous Drain-Source Diode For	rward Current			-0.5	A
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = -0.5 A$ (Note 2)		-0.88	-1.2	V
		W on a 0.005 in ² of pad copper.				



FDC6304P Rev.D



TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

ACEx™ Bottomless™ CoolFET™ CROSSVOLT™ DenseTrench™ DOME™ **EcoSPARK™** E²CMOS[™] EnSigna™ FACT™ FACT Quiet Series™ FAST ® FASTr™ FRFET™ GlobalOptoisolator[™] POP[™] GTO™ HiSeC™ ISOPLANAR™ LittleFET™ MicroFET™ MicroPak™ MICROWIRE™

OPTOLOGIC™ OPTOPLANAR™ PACMAN™ Power247™ PowerTrench[®] QFET™ QS™ QT Optoelectronics[™] Quiet Series[™] SILENT SWITCHER®

SMART START™ VCX™ STAR*POWER™ Stealth™ SuperSOT[™]-3 SuperSOT[™]-6 SuperSOT[™]-8 SyncFET™ TinyLogic™ TruTranslation[™] UHC™ UltraFET[®]

STAR*POWER is used under license

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY. FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.

2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.				
First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.				
Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.				
Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconduct The datasheet is printed for reference information or				
	In Design First Production Full Production				

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor has against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death ass

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC